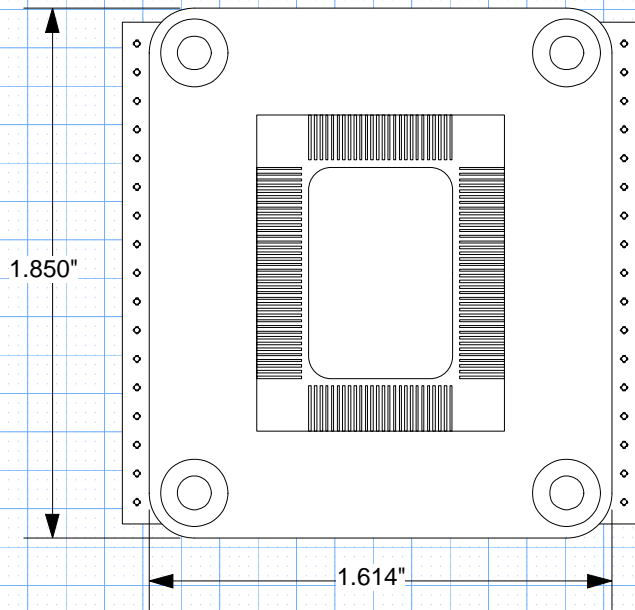
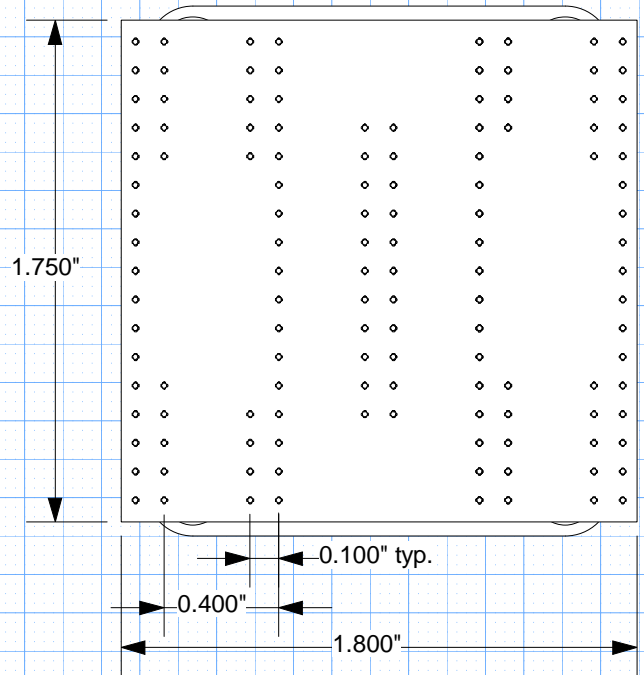


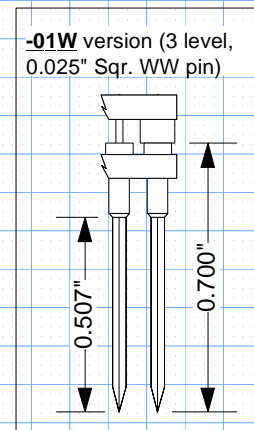
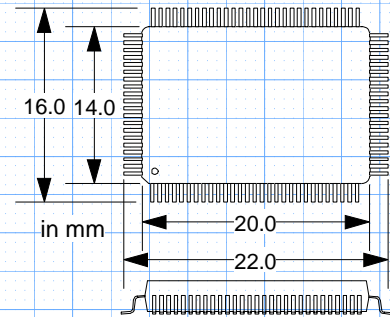
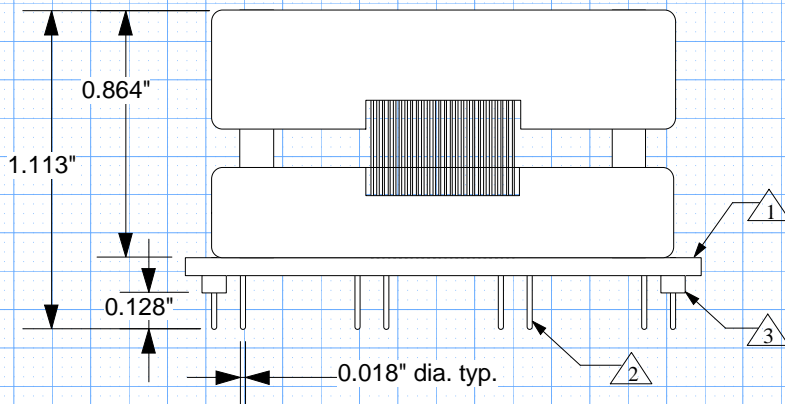
Top View



Bottom View



Side View




- 1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- 2 Pins: Material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.).
- 3 Stand-off: material- Teflon; 0.085" Dia; 0.060" thick.

Description: Prototyping Adaptor

128 position TQFP (RECT 0.5mm pitch) ZIF socket to 128 position PGA prototyping base pattern. Add "W" to part number for optional wire wrap sub-base. To order additional sub-bases use part number

SB-PGA18/128C-01(W)

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.

	PA-QFE128RB-C-Z-01(W) Drawing	Status: Released	Scale: 1.5:1	Rev: D
	© 1997 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing by: V. Thao		Date: 11/11/97
		File: PA-QFE128RB-C-Z-01 Dwg	Modified: 8/10/98	